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Kind regards,

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### **NPN/NPN** matched double transistors

Rev. 04 — 28 August 2009

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

NPN/NPN matched double transistors in small Surface-Mounted Device (SMD) plastic packages. The transistors in the SOT666 and SOT363 (SC-88) packages are fully isolated internally.

#### Table 1. Product overview

Type number	Package		NPN/NPN h <sub>FE1</sub> /h <sub>FE2</sub>	PNP/PNP
	NXP	JEITA	0.95 complement	complement
PMP4201V	SOT666	-	PMP4501V	PMP5201V
PMP4201G	SOT353	SC-88A	PMP4501G	PMP5201G
PMP4201Y	SOT363	SC-88	PMP4501Y	PMP5201Y

#### 1.2 Features

- Current gain matching
- Base-emitter voltage matching
- Common emitter configuration for SOT353 types
- Application-optimized pinout

### **1.3 Applications**

- Current mirror
- Differential amplifier

### 1.4 Quick reference data

#### Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	stor					
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	45	V
I <sub>C</sub>	collector current		-	-	100	mA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 2 mA	200	290	450	



#### NPN/NPN matched double transistors

Table 2.         Quick reference datacontinued						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per device						
$h_{FE1}/h_{FE2}$	h <sub>FE</sub> matching	$V_{CE} = 5 V;$ $I_C = 2 mA$	[1] 0.98	1	-	
$V_{BE1} - V_{BE2}$	V <sub>BE</sub> matching	$V_{CE} = 5 V;$ $I_{C} = 2 mA$	[2] _	-	2	mV

 $\label{eq:constraint} [1] \quad \mbox{The smaller of the two values is taken as the numerator.}$ 

[2] The smaller of the two values is subtracted from the larger value.

### 2. Pinning information

Pin	Description	Simplified outline	Symbol			
SOT666;	SOT363					
1	base TR1					
2	base TR2	6 5 4				
3	collector TR2					
4	emitter TR2					
5	emitter TR1		1 2 3 006aaa548			
6	collector TR1	001aab555	000443940			
SOT353						
1	base TR1					
2	emitter TR1, TR2					
3	base TR2					
4	collector TR2					
5	collector TR1		1 2 3 006aaa549			

### 3. Ordering information

Table 4.         Ordering information							
Type number	Package						
	Name	Description	Version				
PMP4201V	-	plastic surface-mounted package; 6 leads	SOT666				
PMP4201G	SC-88A	plastic surface-mounted package; 5 leads	SOT353				
PMP4201Y	SC-88	plastic surface-mounted package; 6 leads	SOT363				

PMP4201V\_G\_Y\_4

**NPN/NPN** matched double transistors

### 4. Marking

Table 5.   Marking codes	
Type number	Marking code <sup>[1]</sup>
PMP4201V	EA
PMP4201G	R7*
PMP4201Y	S7*

[1] \* = -: made in Hong Kong

\* = p: made in Hong Kong

\* = t: made in Malaysia

\* = W: made in China

### 5. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor				
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	45	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	6	V
I <sub>C</sub>	collector current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 ms$	-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	SOT666		[1][2] _	200	mW
	SOT353		<u>[1]</u> _	200	mW
	SOT363		<u>[1]</u> _	200	mW
Per device	)				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	SOT666		[1][2] _	300	mW
	SOT353		<u>[1]</u> _	300	mW
	SOT363		<u>[1]</u> _	300	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

**NPN/NPN** matched double transistors

### 6. Thermal characteristics

Table 7.	Thermal characteristics	5				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	sistor					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	SOT666		[1][2] _	-	625	K/W
	SOT353		<u>[1]</u> _	-	625	K/W
	SOT363		<u>[1]</u> _	-	625	K/W
Per devic	ce					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	SOT666		[1][2]	-	416	K/W
	SOT353		<u>[1]</u> _	-	416	K/W
	SOT363		<u>[1]</u> _	-	416	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

### 7. Characteristics

#### Table 8.Characteristics

T<sub>amb</sub> = 25 °C unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transi	stor					
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 30 V; I <sub>E</sub> = 0 A	-	-	15	nA
		V <sub>CB</sub> = 30 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C	-	-	5	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A	-	-	100	nA
h <sub>FE</sub> DC current g	DC current gain	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 10 μA	-	250	-	
		$V_{CE} = 5 V;$ $I_{C} = 2 mA$	200	290	450	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 10 mA; I <sub>B</sub> = 0.5 mA	-	50	200	mV
		I <sub>C</sub> = 100 mA; I <sub>B</sub> = 5 mA	-	200	400	mV
V <sub>BEsat</sub> base-emitter sa voltage	base-emitter saturation voltage	l <sub>C</sub> = 10 mA; l <sub>B</sub> = 0.5 mA	<u>[1]</u> -	760	-	mV
		l <sub>C</sub> = 100 mA; l <sub>B</sub> = 5 mA	<u>[1]</u> -	910	-	mV

PMP4201V\_G\_Y\_4

Product data sheet

**NPN/NPN** matched double transistors

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>BE</sub>	base-emitter voltage	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 2 mA	2 610	660	710	mV
		V <sub>CE</sub> = 5 V; I <sub>C</sub> = 10 mA	<u>[2]</u> -	-	770	mV
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V};$ $I_E = i_e = 0 \text{ A};$ f = 1  MHz	-	-	1.5	pF
C <sub>e</sub>	emitter capacitance	$V_{EB} = 0.5 \text{ V};$ $I_C = i_c = 0 \text{ A};$ f = 1  MHz	-	11	-	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 10 mA; f = 100 MHz	100	250	-	MHz
NF	noise figure	$V_{CE} = 5 V;$ $I_{C} = 0.2 \text{ mA};$ $R_{S} = 2 \text{ k}\Omega;$ f = 10  Hz to 15.7  kHz	-	2.8	-	dB
		$V_{CE} = 5 V; \\ I_{C} = 0.2 \text{ mA}; \\ R_{S} = 2 \text{ k}\Omega; \\ f = 1 \text{ kHz}; \\ B = 200 \text{ Hz}$	-	3.3	-	dB
Per device						
h <sub>FE1</sub> /h <sub>FE2</sub>	h <sub>FE</sub> matching	$V_{CE} = 5 V;$ $I_C = 2 mA$	<u>3</u> 0.98	1	-	
$V_{BE1} - V_{BE2}$	V <sub>BE</sub> matching	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 2 mA	[4] _	-	2	mV

## Table 8.Characteristics ... continued $T_{omb} = 25 \circ C$ unless otherwise specified

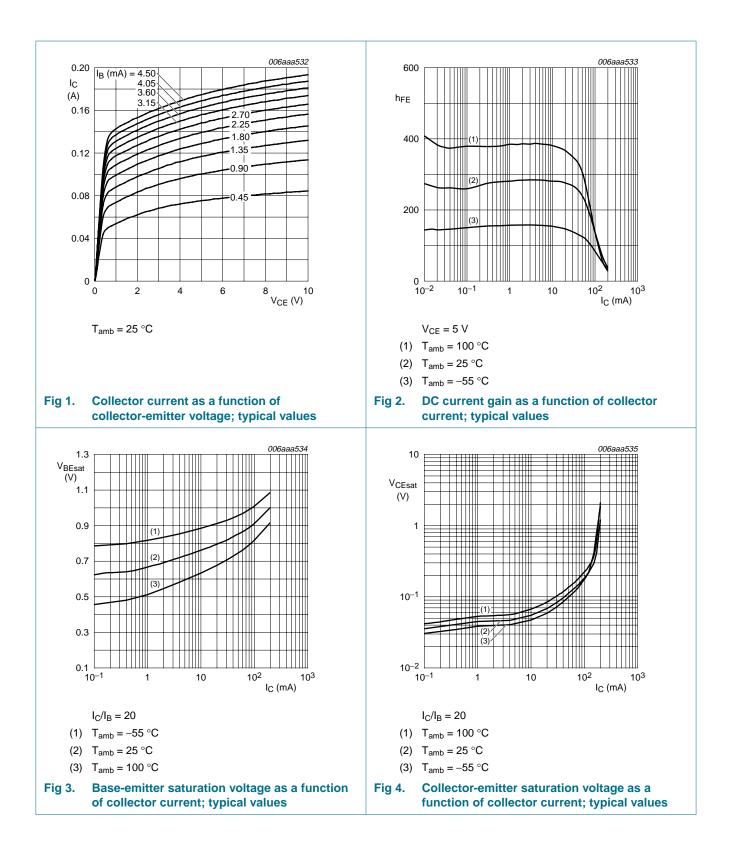
[1]  $V_{BEsat}$  decreases by about 1.7 mV/K with increasing temperature.

[2] V<sub>BE</sub> decreases by about 2 mV/K with increasing temperature.

[3] The smaller of the two values is taken as the numerator.

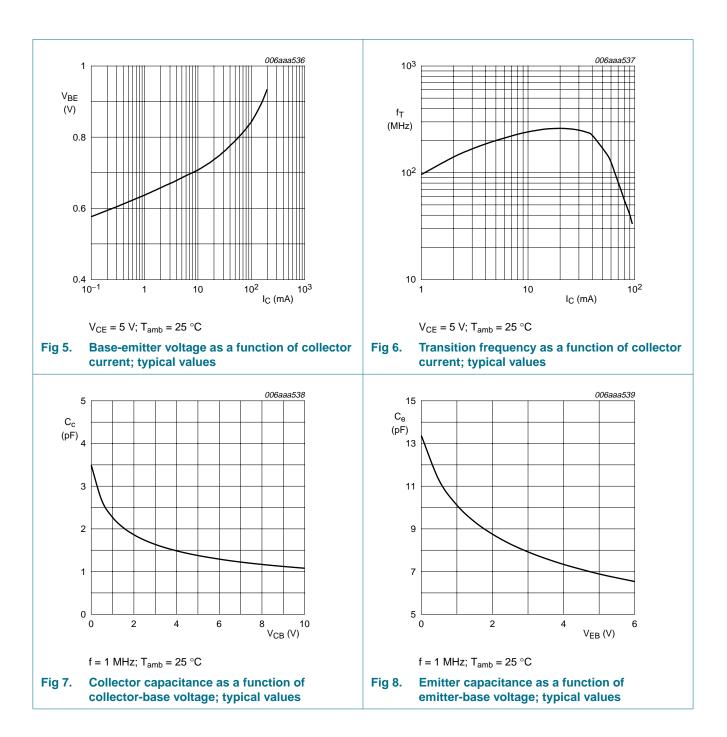
[4] The smaller of the two values is subtracted from the larger value.

**NPN/NPN** matched double transistors



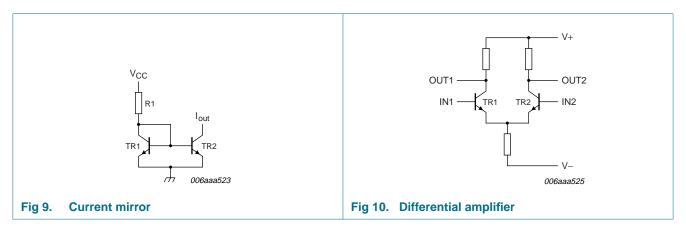
PMP4201V\_G\_Y\_4

**NPN/NPN** matched double transistors

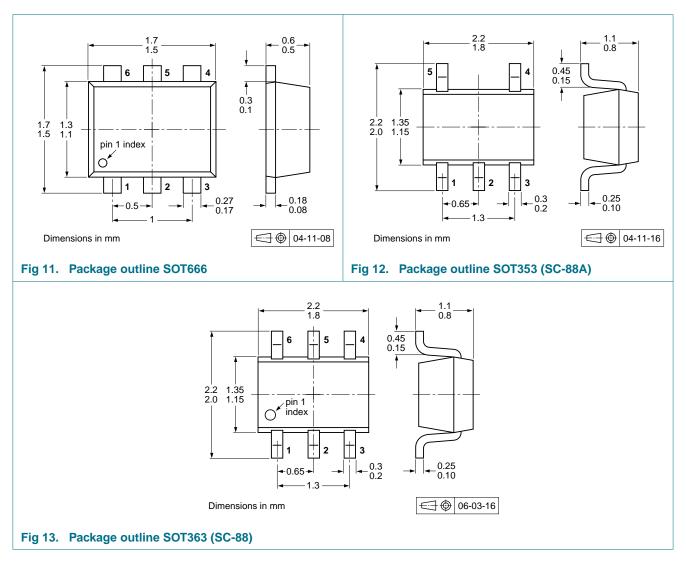


NPN/NPN matched double transistors

# 8. Application information



### 9. Package outline



PMP4201V\_G\_Y\_4

Product data sheet

**NPN/NPN** matched double transistors

### **10. Packing information**

#### Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

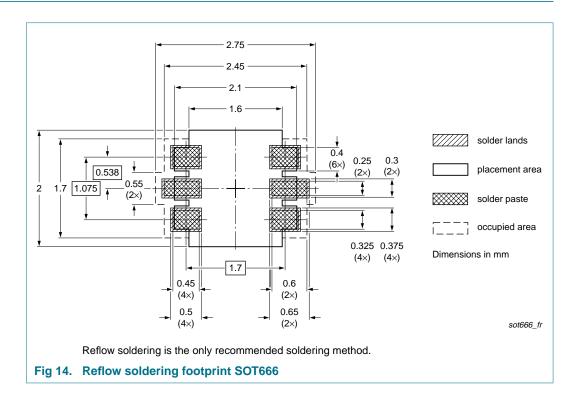
Туре	Package	Description			Packing quantity			
number				3000	4000	8000	10000	
PMP4201V SOT666		2 mm pitch, 8 mm tape and reel		-	-	-315	-	
		4 mm pitch, 8 mm tape and reel		-	-115	-	-	
PMP4201G	SOT353	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
PMP4201Y	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-	-135	
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-	-	-165	

[1] For further information and the availability of packing methods, see Section 14.

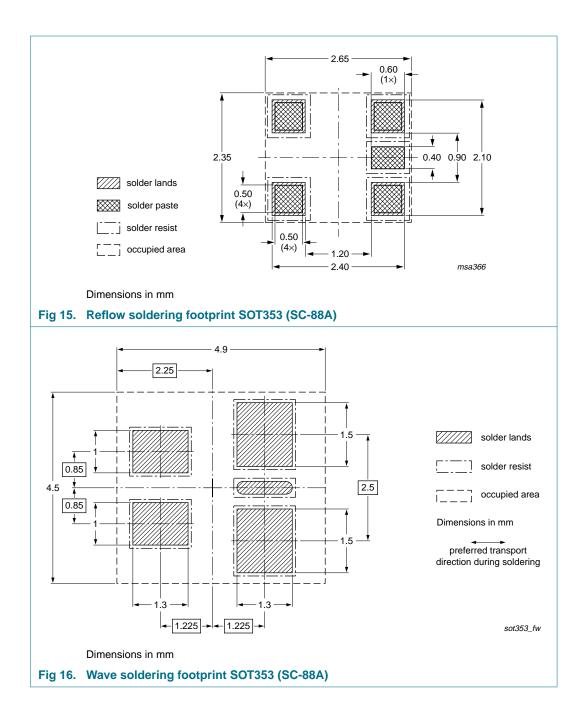
[2] T1: normal taping

[3] T2: reverse taping

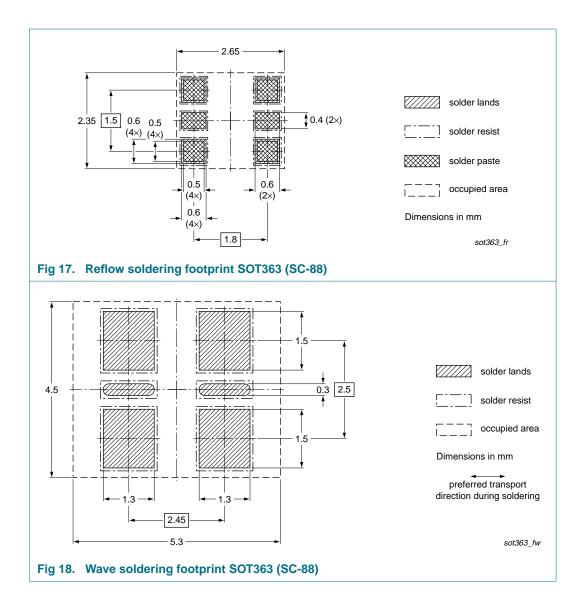
### 11. Soldering



**NPN/NPN** matched double transistors



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### 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
PMP4201V_G_Y_4	20090828	Product data sheet	-	PMP4201V_G_Y_3		
Modifications:		heet was changed to reflec ew legal definitions and dis	• •			
	<ul> <li>Figure 14 "</li> </ul>	Reflow soldering footprint S	OT666": updated			
	Figure 16 "	Wave soldering footprint SC	DT353 (SC-88A)": update	ed		
	<ul> <li>Figure 17 "Reflow soldering footprint SOT363 (SC-88)": updated</li> </ul>					
	Figure 18 "	Wave soldering footprint SC	DT363 (SC-88)": updated	1		
PMP4201V_G_Y_3	20060915	Product data sheet	-	PMP4201G_Y_2		
PMP4201G_Y_2	20060214	Product data sheet	-	PMP4201G_Y_1		

**NPN/NPN** matched double transistors

### 13. Legal information

#### 13.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PMP4201V\_G\_Y\_4

**NPN/NPN** matched double transistors

### **15. Contents**

1	Product profile 1
1.1	General description
1.2	Features
1.3	Applications 1
1.4	Quick reference data
2	Pinning information 2
3	Ordering information 2
4	Marking 3
5	Limiting values
6	Thermal characteristics 4
7	Characteristics 4
8	Application information 8
9	Package outline 8
10	Packing information9
11	Soldering 9
12	Revision history 12
13	Legal information 13
13.1	Data sheet status 13
13.2	Definitions
13.3	Disclaimers
13.4	Trademarks 13
14	Contact information 13
15	Contents 14

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